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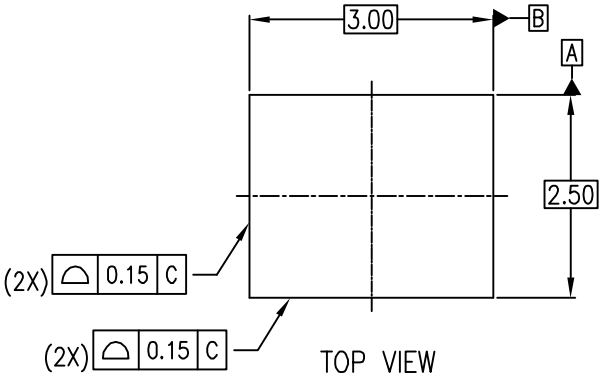
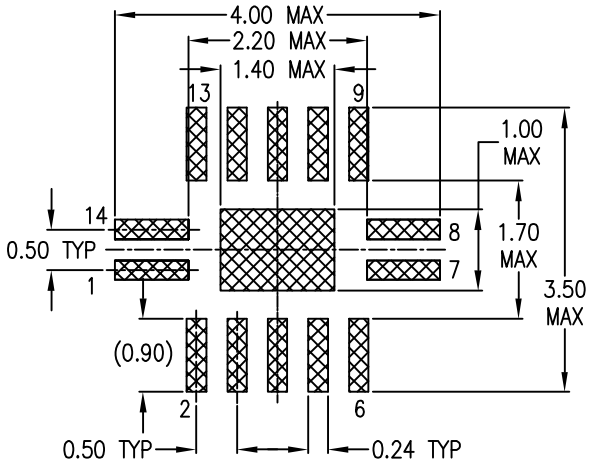
REVISIONS

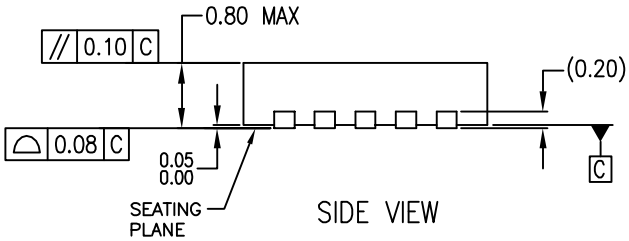
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL		31-3-2003	FEITAN



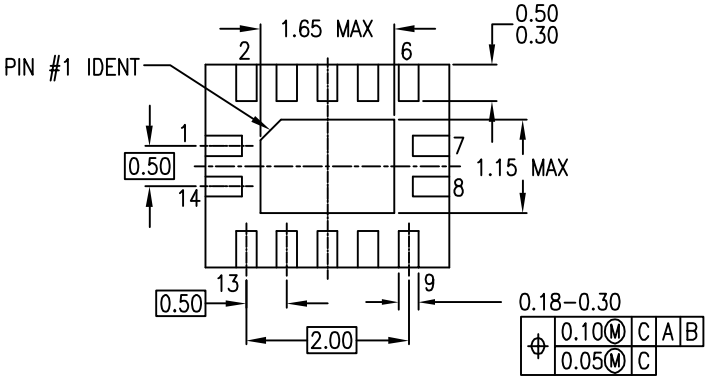
TOP VIEW



RECOMMENDED LAND PATTERN



SIDE VIEW



BOTTOM VIEW

NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

APPROVALS	DATE
DRAWN FEITAN	17-3-2003
DFTG. CHK.	
ENGR. CHK.	

FAIRCHILD SEMICONDUCTOR® Bayan Lepas, FIZ, 11900, Penang, Malaysia.

14LD, DQFN, JEDEC MO-241, 2.5x3.0 MM PACKAGE

PROJECTION INCH [MM]

SCALE	SIZE	DRAWING NUMBER	REV
N/A	N/A	MKT-MLP14A	A

DO NOT SCALE DRAWING — SHEET 1 of 1

MLP14ArevA